



EL465779215

Inventor: **Chris Parf niuk et al.**

Title: **M thods of Bonding First and Second Mass s to One**

*#10/TAS*  
*Refused*  
**Another, and Methods of Bonding Physical Vapor**

*2/14/01*  
**Deposition Target Materials To Backing Plate Materials**

Assignee: **Honeywell International, Inc.**

Serial No.: **09/488,973**

Filed: **CPA Filed Herewith**

Client Ref.: **30-5016-(4015)**

TC 2800 MAIL ROOM

RECEIVED  
NOV 28 2001

**INFORMATION DISCLOSURE STATEMENT**  
**PURSUANT TO 37 C.F.R. §§ 1.56, 1.97 AND 1.98**

In compliance with 37 C.F.R. §§ 1.56, 1.97 and 1.98, the Examiner's attention is directed to the references listed on the attached Form PTO-1449 and copies of which are attached. No admission is made regarding whether all the submitted references are prior art.

Citation of these references is respectfully requested.

Respectfully submitted,

Date: 11/13/01 Attorney: *David*

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